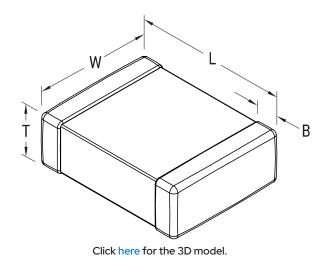


## CBR02C200G3GAC

**General Information** 

Series

CBR-SMD RF COG, Ceramic, 20 pF, 2%, 25 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



Style SMD Chip Description SMD, Fixed, RF, Ultra High Q, Low ESR, Class I Features Ultra High Q, Low ESR, Class I RoHS Yes Termination Tin Marking No AEC-Q200 No Typical Component Weight 0.3 mg Notes Solder Reflow Only. Shelf Life 78 Weeks MSL 1

CBR-SMD RF COG

| Dimensions |                  |
|------------|------------------|
| Chip Size  | 0201             |
| L          | 0.6mm +/-0.03mm  |
| W          | 0.3mm +/-0.03mm  |
| т          | 0.3mm +/-0.03mm  |
| В          | 0.15mm +/-0.05mm |

15000

T&R, 180mm, Plastic Tape

| Packaging Specifications |  |
|--------------------------|--|
| Packaging                |  |

Packaging Quantity

Specifications Capacitance 20 pF Tolerance 2% Voltage DC 25 VDC **Dielectric Withstanding Voltage** 62.5 VDC **Temperature Range** -55/+125°C COG Temp. Coefficient 0.125% **Dissipation Factor** 0% Loss/Decade Hour Aging Rate Insulation Resistance 10 GOhms **Quality Factor** 800

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